

## **Quarterly Reliability Monitoring Results**

Quarters: Q1/2021 to Q4/2021

Based on structural similarity

| Supplier   |                             | User Part Number                                     |             |           |            |           |  |   |
|--|-----------------------------|--|-------------|-----------|------------|-----------|--|---|
| Nexperia B.V.<br>Name of Laboratory<br>Assembly reliability labs<br>Based on AEC-Q101 Test |                             | NHDTC124EU Part Description                          |             |           |            |           |  |   |
|  |                             |  |             |           |            |           |  | Nexperia DHAM Small Signal Bipolar Transistor |
|  |                             | SMD package  |             |           |            |           |  |   |
|  |                             | Test Conditions                                      | Duration    | # Lots    | # Quantity | # Rejects |  |   |
|  |                             |  | TEST        |           |            |           |  |   |
|  | Pre- and Post-Stress        |  |             |           |            |           |  |   |
| # E1   | Electrical Test             | Tamb = 25 °C   | N/A         | see below | all parts  | see below |  |   |
|  |                             | JESD22-A113  |             |           |            |           |  |   |
|  |                             | Bake Tamb = 125 °C                                   | 24 hours    |           |            |           |  |   |
|  | PC                          | Soak Tamb = 85 °C, RH = 85%                          | 168 hours   |           |            |           |  |   |
| # A1   | Preconditioning             | Reflow soldering                                     | 3 cycles    | 849       | 61170      | 0         |  |   |
|  |                             | MIL-STD-750-1  |             |           |            |           |  |   |
|  | HTRB                        | M1039 Method A                                       |             |           |            |           |  |   |
|  |                             | Tj = Tjmax, Vr = 100% of max. datasheet              |             |           |            |           |  |   |
| # B1   | Bias                        | reverse voltage                                      | 1000 hours  | 202       | 16160      | 0         |  |   |
|  | тс                          | JESD22-A104  |             |           |            |           |  |   |
| # A4   | Temperature Cycling         | -65 °C to Tjmax, not to exceed 150°C                 | 1000 cycles | 171       | 13680      | 0         |  |   |
|  |                             | JESD22-A102  |             |           |            |           |  |   |
|  | AC                          | Tamb = $121 ^{\circ}C$ , RH = $100 ^{\circ}M$        |             |           |            |           |  |   |
| # A3 alt   | Autoclave                   | Pressure = 205 kPa (29.7 psia)                       | 96 hours    | 173       | 13840      | 0         |  |   |
|  |                             |  |             |           |            |           |  |   |
|  | H3TRB                       | JESD22-A101  |             |           |            |           |  |   |
|  | High Humidity High          | Tamb = 85 °C, RH = 85%, VR = 80 % of                 |             |           |            |           |  |   |
| # A2 alt   | Temperature Reverse Bias    | rated reverse voltage <sup>[1]</sup>                 | 1000 hours  | 173       | 13840      | 0         |  |   |
|  |                             | MIL-STD-750 Method 1037                              |             |           |            |           |  |   |
|  | IOL                         | ton = toff, devices powered to insure $\Delta T_j$ = |             |           |            |           |  |   |
| # A5   | Intermittent Operating Life |  | 1000 hours  | 197       | 15760      | 0         |  |   |
|  |                             | · ·  |             |           |            | -         |  |   |
|  | RSH                         | JESD22-A111  |             |           |            |           |  |   |
| # C8   | Resistance to Solder Heat   |  | 10 s        | 135       | 4050       | 0         |  |   |
|  | SD                          |  |             |           |            | -         |  |   |
| # C10  | Solderability               | J-STD-002  |             | 342       | 3420       | 0         |  |   |

[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

## **Calculation of FIT and MTTF**

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1) Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

| Wafer Fab        | Technology                         | Quantity | Rejects | Failure Rate (FIT) | MTTF (hrs) |
|------------------|------------------------------------|----------|---------|--------------------|------------|
| Nexperia<br>DHAM | Small Signal Bipolar<br>Transistor | 16160    | 0       | 0.26               | 3.81E+09   |

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